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Question Bank

S	Subject Code :79716	Subject Name : Electronics Paper XII, Power Electronics Devices and Applications			
	Common subject	t Code (if any)			
Q.	1 Select correct alter	natives.			
1.	Conductivity modulation is a process where holes and electrons both are injected into				
	the layer.				
	A) emitter	B) base			
	C) drift	D) collector			
2.	The process of conductivity modulation result in the reduction in				
	A) voltage	B) On state losses			
	C) current	D) voltage and current			
3.	The operation of power is basically dependant on the principle of creation of				
	inversion layer.				
	A) BJT	B) UJT			
	C) Diode	D) MOSFET			
4.	The power is a current controlled device				
	A) MOSFET	B) BJT			
	C) SCR	D) UJT			
5.	Which of the follow	ving device has the terminals collector, emitter ,gate			
	A) BJT	B) SCR			
	C) IGBT	D) MOSFET			
6.	A power diode uses	s the vertically oriented structure as it reduces on state			
	•••••				
	A) voltage drop	B) switching frequency			
	C) output current	D) none of these			

7.	The reverse recovery current in power diode depends upon			
	A) storage charge	B)temperature		
(C) Forward current	D) PIV		
8. The power MOSFET is a controlled device				
	A) current	B) voltage C) power		
	D) non	e of these		
9.	is a unidirectional device with three terminals.			
	A) Triac	B) Diac		
	C) SCR	D) none of these		
10 structure is obtained by adding an insulated gate to the power trans				
	and pt layer.			
	A) BJT	B) IGBT		
	C) SCR	D) MOSFET		
11.	CR is degree, then its conduction angle 120 degree			
	A) 150	B) 90		
	C) 120	D) 60		
12. The forward breakover voltage of SCR is decreased by increasing				
	A) anode current	B) anode voltage		
	C) gate current	D) none of these		
13 is a bidirectional device with three terminals.				
	A) SCR	B) Triac		
	C) Diode	D) none of these		
14.	14. The current is generated due to thermally generated electron-hole pair			
	A) leakage	B) forward		
15.	C) reverse The latching current is	D) none of these holding current.		
	A) less than	B) equal to		
	C)greater than	D) none of these		
16.	The rat	ing of an SCR is specified for its rising anode current.		

	A) L di/dt	B) dv/dt		
	C)di/dt	D) None of these		
17.	is an equivalent to two thyristor in antiparallel.			
	A) SCR	B) Triac		
(C)Diac	D) BJT		
18.	For uncontrolled rectific	ation is used.		
	A) Diode	B) BJT		
	C) UJT	D) IGBT		
19. The phase voltage are phase shifted from each other by degree				
	A) 90	B) 120		
	C) 150	D) 180		
20. The voltage of an uncontrolled rectifier is always fixed and positive				
	A) output	B) input		
	C) input or output	D) none of these		
21. The voltage measured between any two phases is called as voltage.		etween any two phases is called as voltage.		
	A) Phase	B) line		
	B) Line and phase	D) none of these		
22.	is a bidirectiona	l device with three terminals.		
	B) SCR	B) Triac		
	C) Diode	D) none of these		
23.	An inductance is connect	ted in series with the to protect it against damage due to		
	high di/dt			
	A) BJT	B) Diode		
	C) SCR	D) none of these		
24.	Power MOSFET is a carrier device			
	A) majority	B) minority		
	C) both A & B	D) none of these		
25.	The width of the	layer is always compromise between on state losses and		

breakdown voltage.

A) emitter	B)	base
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C) collector D) drift

26. A silicon controlled rectifier (SCR) is a_____.

- a) Uni-junction device
- b) Device with three junction
- c) Device with four junction
- d) None of the above

27. A thyristor is basically_____.

- a) PNPN device
- b) A combination of diac and triac
- c) A set of SCRs
- d) A set of SCR, diac and a triac

28. Which semiconductor power device out of the following is not a current triggering device?

- a) Thyristor
- b) Triac
- c) G.T.O
- d) MOSFET

29. Power diodes are used in_____.

- a) Rectifier
- b) Mixer
- c) Amplifier
- d) None of these

30. The MOSFET combines the areas of _____ & _____

- a) Field effect & MOS technology
- b) semiconductor & TTL
- c) MOS technology & CMOS technology
- d) none of the mentioned

31. Which of the following terminals does not belong to the MOSFET?

- a) Drain
- b) Gate
- c) Base
- d) Source

32. Choose the correct statement

- a) MOSFET is an uncontrolled device
- b) MOSFET is a voltage controlled device
- c) MOSFET is a current controlled device
- d) MOSFET is a temperature controlled device

33. A power transistor is a _____

- a) three layer, three junction device
- b) three layer, two junction device
- c) two layer, one junction device
- d) four layer, three junction device

34. Insulated-gate bipolar transistor (IGBT) has combinational advantages of_____.

- a) BJTs and SITs
- b) BJTs and MOSFETs
- c) SITs and MOSFETs
- d) FETs and BJTs

35. In the internal structure of a MOSFET, a parasitic BJT exists between the_____.

- a) source & gate terminals
- b) source & drain terminals
- c) drain & gate terminals
- d) there is no parasitic BJT in MOSFET

36. Which of the following devices does not belong to the transistor family?

- a) IGBT
- b) MOSFET
- c) GTO
- d) BJT

37. The forward current gain α is given by_____.

- а) Іс/Ів
- b) I_C/I_E
- c) I_E/I_C
- d) I_E/I_B

38. The holding current is ______.

- a) Less than latching current.
- b) Higher than latching current.
- c) Equal to latching current.
- d) None of these.

39. Conductivity modulation takes place in case of _____

- a) SCR
- b) Diac
- c) Triac
- d) Power diode

40. For a single phase half wave rectifier, with R load, the diode is reversed biased from ωt = _____.

- a) 0 to π, 2π to 2π/3
 b) π to 2π, 2π/3 to 3π
 c) π to 2π, 2π to 2π/3
 d) 0 to π, π to 2π
- 41. In a single phase HW diode rectifier with R load, the average value of load current is given by
 - a) Vm/R
 - b) Vm/2R
 - c) $Vm/\pi R$
 - d) Zero

42. The holding current I_H is_____.

- a) Important at the time of turn on
- b) Important while turning off the SCR
- c) The maximum permissible value of anode current
- d) None of the above

43. In silicon controlled rectifier, the load is connected ______.

- a) In series with anode
- b) Across anode
- c) In series with cathode
- d) Across cathode

44. If the firing angle in case of SCR circuit is increased then output _____

- a) Remains constant
- b) Decreases
- c) Increases
- d) None of the above

45. The advantage of using freewheeling diode in half controlled bridge converter is that_____.

- a) There is always a path for the DC current independent of the AC line
- b) There is always a path for the AC current independent of the ac line
- c) There is always a path for the DC current dependent of the ac line
- d) There is always a path for the AC current independent of the ac line

46. An inductance is connected in series with SCR to protect it against _____.

- a) Damage due to high dv/dt
- b) Damage due to high di/dt
- c) Damage due to large forward current
- d) None of the above

47. The turn off time will reduce with_____.

- a) Reduction in the reverse voltage.
- b) Increase in the reverse voltage
- c) Increase in the forward voltage
- d) Reduction in forward voltage

48. The control element of an SCR is _____.

- a) Anode
- b) Cathode
- c) Gate
- d) Anode supply

49. One method of forming a three-phase system is to connect the three similar ends of the windings together at one point. This type of connection is called

a) Parallel connection

- b) Delta connection
- c) Star connection
- d) Mesh connection

50. The phase voltages are phase shifted from each other by ______degrees.

- a) 90
- b) 150
- c) 120
- d) 180

Q. 2 Long answers

- 1) Explain Construction, working and I-V characteristics of power diode.
- 2) Explain structure and characteristics of Power MOSFET.
- 3) Explain comparison of MOSFET and IGBT.
- 4) Explain structure and I-V characteristics of SCR.
- 5) Explain concept of di/dt and dv/dt protection and also explain Thyristor rating 6) Explain concept of firing angle and half wave controlled convertor with resistive load.
- 7) Explain comparison of HWR, FWR and FWBR.
- 8) Explain single phase bidirectional controller with resistive load.
- 9) Explain applications of power diode.
- 10) Explain structure, operation and drive circuits of IGBT.
- 11) Explain the working of full wave controlled rectifier with neat diagrams and derive the relation for average output voltage for resistive load.

Q. 3 Short answers

- 1) Explain any two applications of Power Electronics
- 2) Explain the types of diodes
- 3) Explain with neat diagram I-V characteristics of power diode.

- 4) Define latching and holding currents in case of SCR.
- 5) Write a short note on Power MOSFET. 6) Explain operation and drive circuit of MOSFET 7) Explain applications of IGBT.
- 8) What is the principle of operation of IGBT?
- 8) Explain construction and working of TRIAC.
- 9) Explain the MOS controlled thyristor.
- 10) Explain the two transistor analogy of SCR.
- 11) Explain the concept of firing angle and conduction angle.
- 12) What is the working principle of controlled rectifiers?
- 13) How does a controlled rectifier used in DC drive?
- 14) What is the half controlled rectifier?
- 15) Explain principle of ON/OFF control.
- 16) Explain what is SMPS and its application.
- 17) Explain any one type of UPS with block diagram.
- 18) What is the principle of induction and dielectric heating?
- 19) Explain the characteristics of power transistor.
- 20) What is structure of IGBT?
- 21) Explain the working principal of induction heating?
- 22) What is uncontrolled bridge rectifier?
- 23) Explain the concept of di/dt and dv/dt protection.
- 24) Explain the concept of single phase and three phase supplies.
- 25) What is conductivity modulation?
- 26) Explain the use of freewheeling diode.